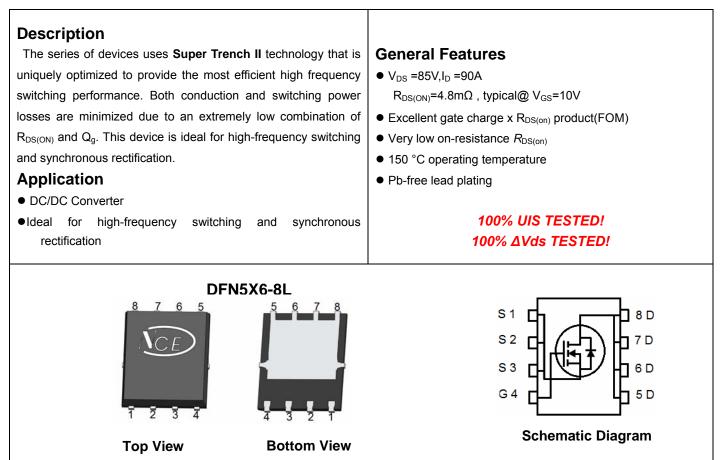


## NCE N-Channel Super Trench II Power MOSFET



## Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
P058N85GU	NCEP058N85GU	DFN5X6-8L	-	-	-

## Absolute Maximum Ratings (T<sub>c</sub>=25℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	Vds	85	V
Gate-Source Voltage	Vgs	±20	V
Drain Current-Continuous	Ι <sub>D</sub>	90	А
Drain Current-Continuous(T <sub>C</sub> =100°C)	I <sub>D</sub> (100℃)	66	A
Pulsed Drain Current	I <sub>DM</sub>	360	A
Maximum Power Dissipation	PD	105	W
Derating factor		0.84	W/℃
Single pulse avalanche energy (Note 5)	E <sub>AS</sub>	423	mJ
Operating Junction and Storage Temperature Range	T <sub>J</sub> ,T <sub>STG</sub>	-55 To 150	്റ

## **Thermal Characteristic**

Thermal Resistance, Junction-to-Case <sup>(Note 2)</sup>	R <sub>eJC</sub>	1.2	°C/W
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## Electrical Characteristics (T<sub>c</sub>=25<sup>°</sup>C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Мах	Unit
Off Characteristics	····		·	•		
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V I <sub>D</sub> =250µA	85		-	V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS}$ =85V, $V_{GS}$ =0V	-	-	1	μA
Gate-Body Leakage Current	I <sub>GSS</sub>	$V_{GS}$ =±20V, $V_{DS}$ =0V	-	-	±100	nA
On Characteristics (Note 3)	····		·	•		
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS}=V_{GS}$ , I <sub>D</sub> =250µA	2.0	3.0	4.0	V
Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	$V_{GS}$ =10V, I <sub>D</sub> =45A	-	4.8	5.8	mΩ
Forward Transconductance	<b>g</b> fs	V <sub>DS</sub> =5V,I <sub>D</sub> =45A		60	-	S
Dynamic Characteristics (Note4)			•			
Input Capacitance	C <sub>lss</sub>		-	3100	-	PF
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> =40V,V <sub>GS</sub> =0V, F=1.0MHz	-	483	-	PF
Reverse Transfer Capacitance	C <sub>rss</sub>		-	28	-	PF
Switching Characteristics (Note 4)	····		·	•		
Turn-on Delay Time	t <sub>d(on)</sub>	V <sub>DD</sub> =40V,I <sub>D</sub> =45A V <sub>GS</sub> =10V,R <sub>G</sub> =1.6Ω	-	13.5	-	nS
Turn-on Rise Time	tr		-	11	-	nS
Turn-Off Delay Time	t <sub>d(off)</sub>		-	32	-	nS
Turn-Off Fall Time	t <sub>f</sub>		-	11	-	nS
Total Gate Charge	Qg	V <sub>DS</sub> =40V,I <sub>D</sub> =45A, V <sub>GS</sub> =10V	-	51	-	nC
Gate-Source Charge	Q <sub>gs</sub>		-	17.7		nC
Gate-Drain Charge	Q <sub>gd</sub>	V <sub>GS</sub> =10V	-	13.3		nC
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 3)	V <sub>SD</sub>	V <sub>GS</sub> =0V,I <sub>S</sub> =45A	-		1.2	V
Diode Forward Current (Note 2)	I <sub>S</sub>		-	-	90	Α
Reverse Recovery Time	t <sub>rr</sub>	T <sub>J</sub> = 25°C, I <sub>F</sub> = 45A	-	58	-	nS
Reverse Recovery Charge	Qrr	di/dt = 100A/ $\mu$ s <sup>(Note3)</sup>	-	74	-	nC

#### Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.

2. Surface Mounted on FR4 Board,  $t \le 10$  sec.

3. Pulse Test: Pulse Width ≤ 300 $\mu$ s, Duty Cycle ≤ 2%.

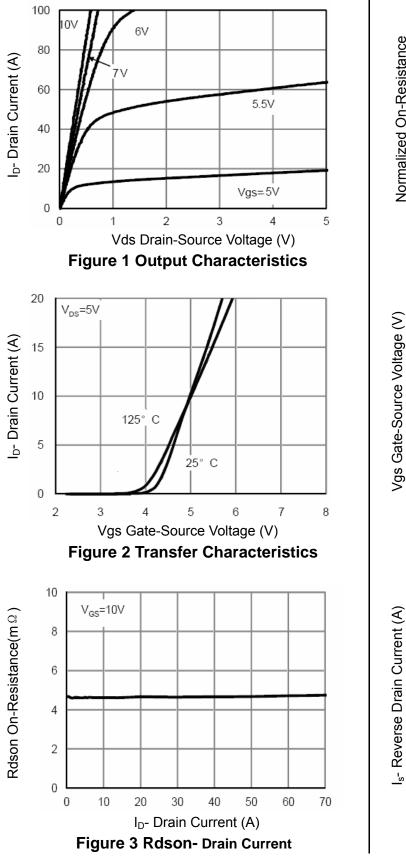
4. Guaranteed by design, not subject to production

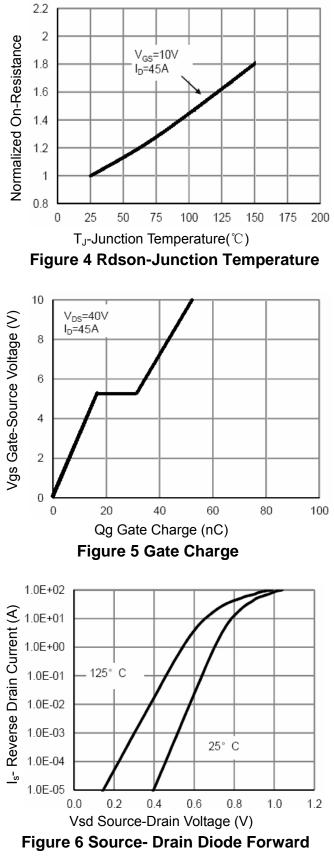
5. EAS condition : Tj=25  $^\circ \!\! \mathbb{C}$  ,V\_{DD}=40V,V\_G=10V,L=0.5mH,Rg=25  $\Omega$ 



# NCEP058N85GU









## NCEP058N85GU

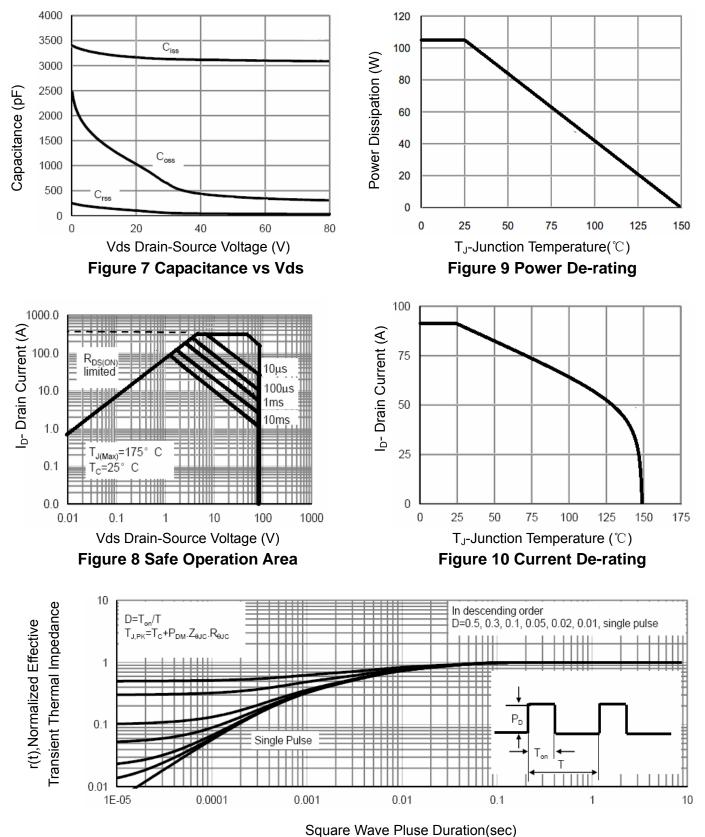
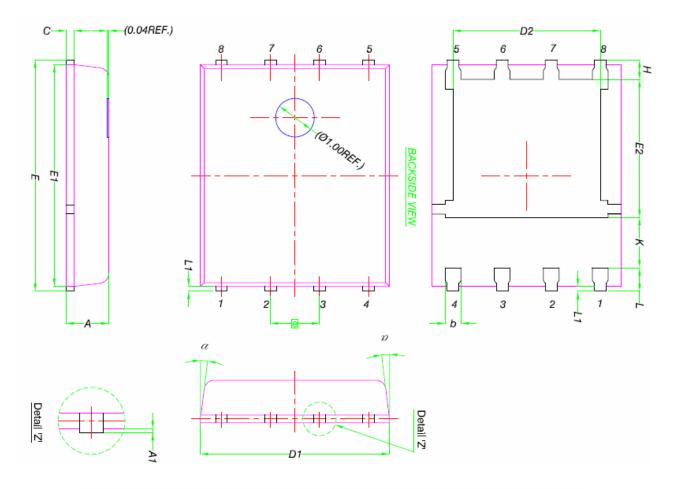


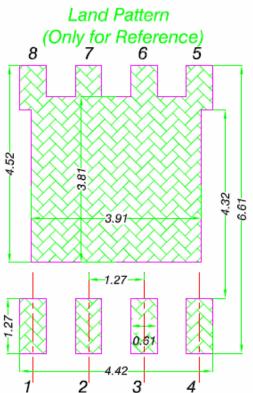
Figure 11 Normalized Maximum Transient Thermal Impedance



## DFN5X6-8L Package Information



	MILLIMETERS			
DIM.	MIN.	NOM.	MAX.	
Α	0.90	1.00	1.10	
A1	0	-	0.05	
b	0.33	0.41	0.51	
С	0.20	0.25	0.30	
D1	4.80	4.90	5.00	
D2	3.61	3.81	3.96	
Е	5.90	6.00	6.10	
E1	5.70	5.75	5.80	
E2	3.38	3.58	3.78	
е	1.27 BSC			
Н	0.41	0.51	0.61	
к	1.10	-	-	
L	0.51	0.61	0.71	
L1	0.06	0.13	0.20	
α	0°	-	12°	





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